



1400-1600MHz, 350W, 28V High Power RF LDMOS FETs

Description

The ITCH17351C2 is a 350-watt, internally matched LDMOS FETs, designed for multiple applications with frequencies from 1400 to 1600 MHz.

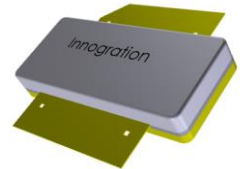
It Can be used in Class AB/B and Class C for all typical modulation formats.

- Typical Performance (on test board with devices soldered):

$V_{DS}=28V, I_{DQ}=330mA$, CW

| Freq(MHz) | Pin(dBm) | Pout(W) | Ids(A) | Gain(dB) | Eff(%) |
|-----------|----------|---------|--------|----------|--------|
| 1475 | 39.9 | 325.1 | 20.35 | 15.22 | 57.1% |
| 1500 | 39.8 | 316.2 | 19.6 | 15.2 | 57.6% |
| 1525 | 39.8 | 316.2 | 19.7 | 15.2 | 57.3% |

ITCH17351C2



Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Internally Matched for Ease of Use
- Optimized for Doherty Applications
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Excellent thermal stability, low HCI drift
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|--------------------------------|-----------|-------------|------|
| Drain--Source Voltage | V_{DSS} | 70 | Vdc |
| Gate--Source Voltage | V_{GS} | -10 to +10 | Vdc |
| Operating Voltage | V_{DD} | +32 | Vdc |
| Storage Temperature Range | T_{stg} | -65 to +150 | °C |
| Case Operating Temperature | T_c | +150 | °C |
| Operating Junction Temperature | T_j | +225 | °C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Thermal Resistance, Junction to Case Case Temperature 80°C, 350W Pulsed Output | $R_{\theta JC}$ | 0.22 | °C/W |

Table 3. ESD Protection Characteristics

| Test Methodology | Class |
|-------------------------------------|---------|
| Human Body Model (per JESD22--A114) | Class 2 |

Table 4. Electrical Characteristics (TA = 25 °C unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

DC Characteristics

| | | | | | |
|--------------------------------|-----------|----|---|---|---|
| Drain-Source Breakdown Voltage | V_{DSS} | 65 | — | — | V |
|--------------------------------|-----------|----|---|---|---|



| | | | | | |
|---|---------------------|-----|-----|-----|----|
| (V _{GS} =0V; I _D =100uA) | | | | | |
| Zero Gate Voltage Drain Leakage Current (V _{DS} = 28 V, V _{GS} = 0 V) | I _{DSS} | —— | —— | 10 | μA |
| Gate--Source Leakage Current (V _{GS} = 6 V, V _{DS} = 0 V) | I _{GSS} | —— | —— | 1 | μA |
| Gate Threshold Voltage (V _{DS} = 28V, I _D = 600 uA) | V _{GS(th)} | —— | 1.6 | —— | V |
| Gate Quiescent Voltage (V _{DS} = 28 V, I _{DQ} = 350 mA, Measured in Functional Test) | V _{GS(Q)} | 2.1 | 2.6 | 3.1 | V |

Functional Tests (In Innegration Test Fixture, 50 ohm system) : V_{DS} = 28 Vdc, I_{DQ} = 350 mA, f = 1400 MHz, Pulse CW Signal Measurements.

(Pulse Width=20 μs, Duty cycle=10%)

| | | | | | |
|-----------------------------------|-------------------|----|----|----|-----|
| Power Gain @ P _{1dB} | G _p | —— | 17 | —— | dB |
| Drain Efficiency@P _{3dB} | η _D | —— | 57 | —— | % |
| 3dB Compression Point | P _{-3dB} | —— | 55 | —— | dBm |
| Input Return Loss | IRL | —— | -7 | —— | dB |

Load Mismatch of per Section (On Test Fixture, 50 ohm system): V_{DD} = 28 Vdc, I_{DQ} = 350 mA, f = 1400 MHz

| | |
|--|-----------------------|
| VSWR 5:1 at 350W pulse CW Output Power | No Device Degradation |
|--|-----------------------|

Reference Circuit of Test Fixture Assembly Diagram

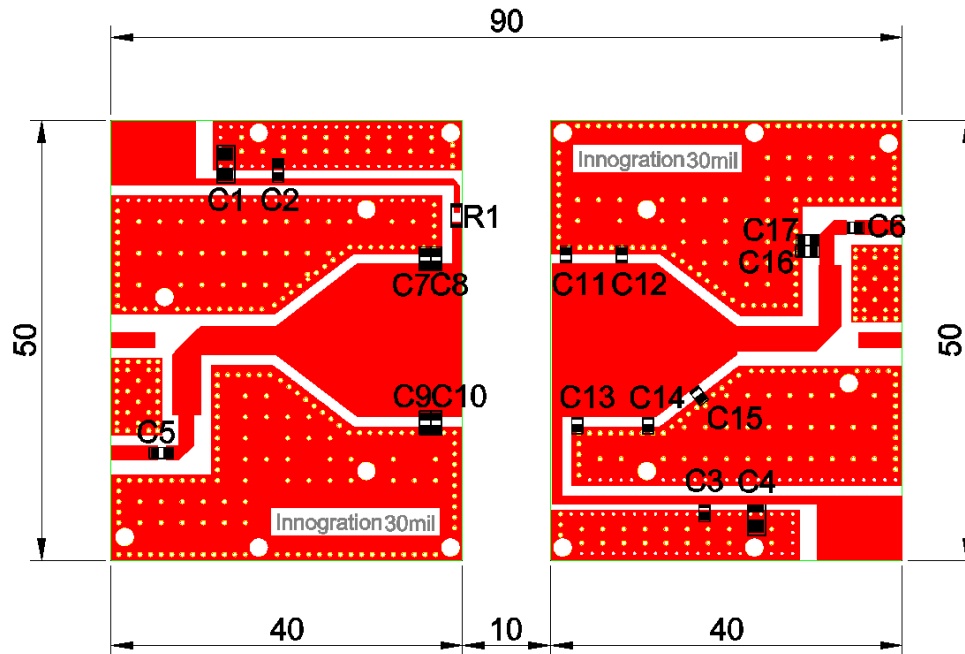


Figure 1. Test Circuit Component Layout (1475-1525MHz)



Table 1. Test Circuit Component Designations and Values

| Component | Description | Suggested Manufacturer |
|-------------|-------------------------|------------------------|
| C2、C3、C5、 | 39pF | DLC70B |
| C6 | 10pF*4 | DLC70B |
| C1、C4、 | 10uF/50V | 1210 |
| C7、C9 | 1.0pF | DLC70B |
| C8、C10 | 2.7pF | DLC70B |
| C11、C13 | 4.7pF | DLC70B |
| C12、C14、C15 | 1.5pF | DLC70B |
| C16、C17 | 0.5pF | DLC70B |
| R1 | Chip Resistor,9.1Ω,1206 | |
| PCB | 30Mil Rogers 4350B | |

TYPICAL CHARACTERISTICS

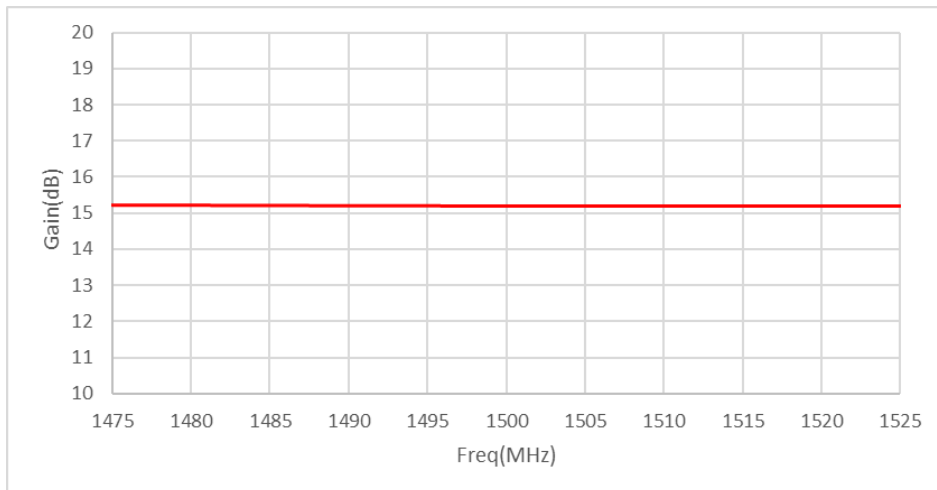
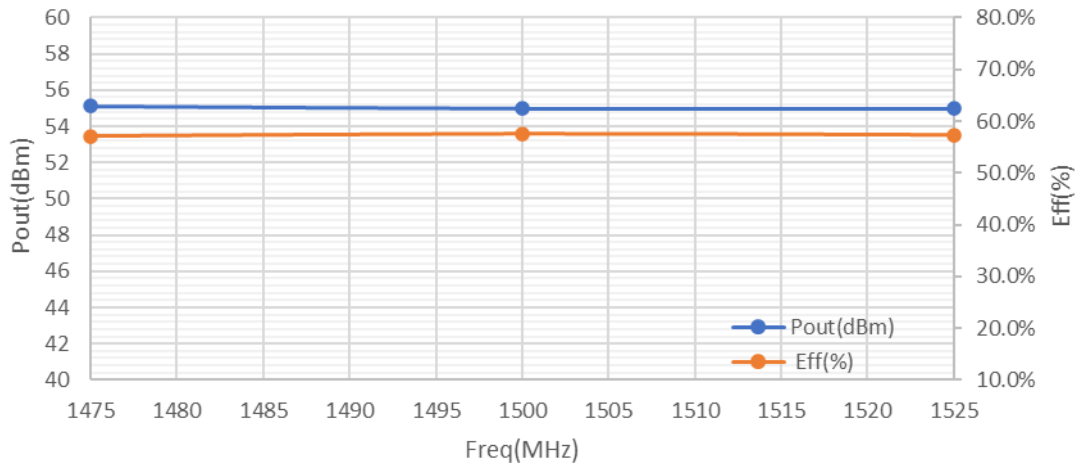


Figure 2. Power Gain and Drain Efficiency as Function of CW Output Power



Figure 3. Network analyzer output S11/S21

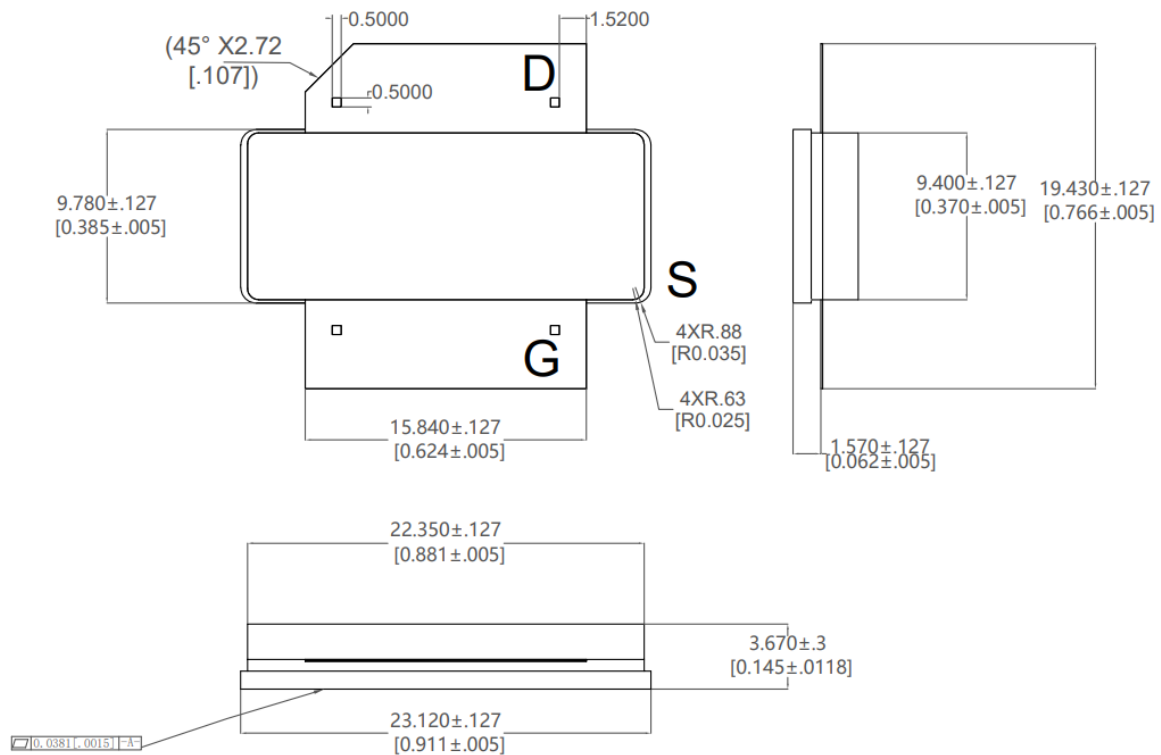
Vgs=2.73V Vds=28V, Idq =1A



Package Outline

Flangeless ceramic package;

INP-688-2-EL (C2)



| OUTLINE VERSION | REFERENCE | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|-----------|-------|-------|------------------------|------------|
| | IEC | JEDEC | JEITA | | |
| PKG-C2 | | | | | 09/27/2018 |



Revision history

Table 6. Document revision history

| Date | Revision | Datasheet Status |
|-----------|----------|---|
| 2022/8/8 | V1.0 | Preliminary Datasheet Creation |
| 2023/5/26 | V1.1 | Modify C6 to multiple smaller caps for power handling |
| 2025/8/28 | V1.2 | Correct C2 drawing |

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